

勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

January 2012

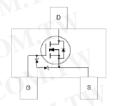
# 2N7002K

# N-Channel Enhancement Mode Field Effect Transistor

### **Features**

- · Low On-Resistance
- · Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Ultra-Small Surface Mount Package
- Pb Free/RoHS Compliant
- ESD HBM=2000V (Typical:3000V) as per JESD22 A114 and ESD CDM=2000V as per JESD22 C101





# Absolute Maximum Ratings \* T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter Drain-Source Voltage		Value	Units V	
V <sub>DSS</sub>			60		
$V_{DGR}$	Drain-Gate Voltage $R_{GS} \le 1.0 M\Omega$		60	V	
V <sub>GSS</sub>	Gate-Source Voltage	X 100	±20	V	
I <sub>D</sub>	Drain Current	Continuous Pulsed	300 800	mA	
	Operating Junction Temperature Range		-55 to +150	°C	
T <sub>STG</sub>	Storage Temperature Range		-55 to +150	°C	

<sup>\*</sup> These ratings are limiting values above which the serviceability of any semiconductor device may by impaired.

### **Thermal Characteristics**

Symbol	Parameter	Value	Units
P <sub>D</sub>	Total Device Dissipation Derating above T <sub>A</sub> = 25°C	350 2.8	mW mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient *	350	°C/W

<sup>\*</sup> Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch. Minimum land pad size

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# **Electrical Characteristics** $T_A = 25$ °C unless otherwise noted

Symbol	Parameter	Test Condition	MIN	MAX	Units
Off Charac	cteristics (Note1)		Ing.	- 00	Mir
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0V$ , $I_D = 10uA$	60	N.O.	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 60V, V_{GS} = 0V$ $V_{DS} = 60V, V_{GS} = 0V, @T_C=125^{\circ}C$	1.10	1.0 500	μА
I <sub>GSS</sub>	Gate-Body Leakage	$V_{GS} = \pm 20V, V_{DS} = 0V$	11.10	±10	μА
On Charac	cteristics (Note1)	TN N	-11	007.	
V <sub>GS(th)</sub>	Gate Threshold Voltage $V_{DS} = V_{GS}$ , $I_D = 250uA$		1.0	2.5	V
R <sub>DS(ON)</sub>	Satic Drain-Source On-Resistance	$V_{GS} = 10V, I_D = 0.5A$ $V_{GS} = 4.5V, I_D = 200mA$		2 4	Ω
I <sub>D(ON)</sub>	On-State Drain Current	V <sub>GS</sub> = 10V, V <sub>DS</sub> = 7.5V	1.5	1100	Α
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 10V, I_{D} = 0.2A$	200	10.2	mS
Dynamic	Characteristics		11	4X1 10	Ar.
C <sub>iss</sub>	Input Capacitance	COL		50	pF
C <sub>oss</sub>	Output Capacitance	$V_{DS} = 25V, V_{GS} = 0V, f = 1.0MHz$		15	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	COM		6	pF
Switching	Characteristics	COMM	7	-TIW	In
t <sub>D(ON)</sub>	Turn-On Delay Time	V <sub>DD</sub> = 30V, I <sub>DSS</sub> = 200mA,		5	ns
t <sub>D(OFF)</sub>	Turn-Off Delay Time	$R_G = 10\Omega$ , $V_{GS} = 10V$		30	

Note1: Short duration test pulse used to minimize self-heating effect.

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## **Typical Performance Characteristics**

Figure 1. On-Region Characteristics

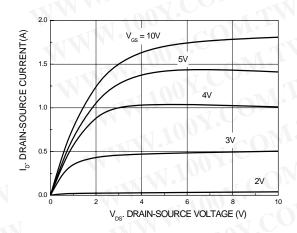


Figure 3. On-Resistance Variation with Temperature

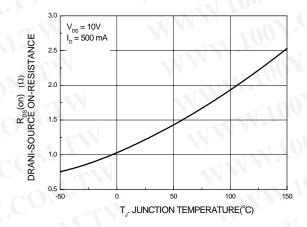


Figure 5. Transfer Characteristics

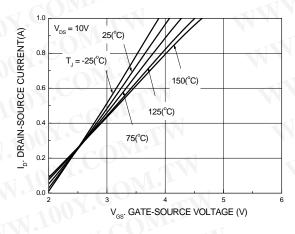


Figure 2. On-Resistance Variation with Gate Voltage and Drain Current

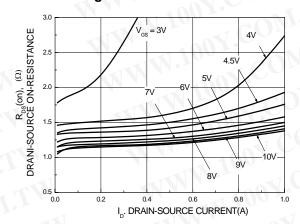


Figure 4. On-Resistance Variation with Gate-Source Voltage

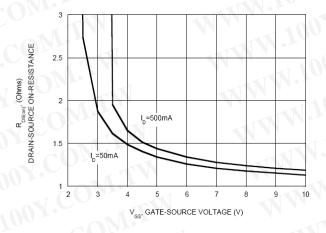
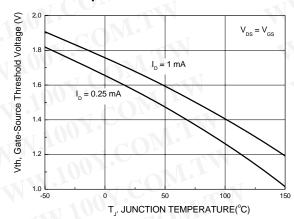
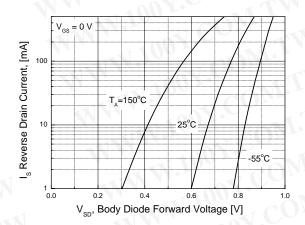


Figure 6. Gate Threshold Variation with Temperature



### **Typical Performance Characteristics** (Continue)

Figure 7. Reverse Drain Current Variation with Diode Forward Voltage and Temperature

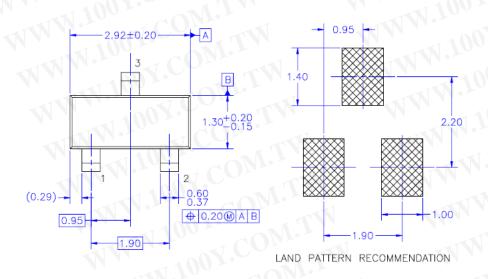


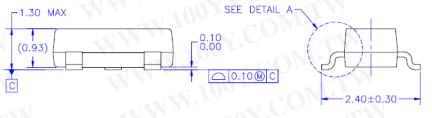
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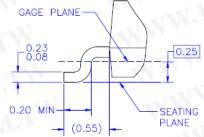
## **Physical Dimensions**

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# SOT-23







DETAIL A

### NOTES: UNLESS OTHERWISE SPECIFIED

- REFERENCE JEDEC REGISTRATION TO-236, VARIATION AB, ISSUE H.
  ALL DIMENSIONS ARE IN MILLIMETERS.
  DIMENSIONS ARE INCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR EXTRUSIONS.
  DIMENSIONING AND TOLERANCING PER ASME Y14.5M 1994.
  DRAWING FILE NAME: MAO3DREV9
- B) C)
- D)
- E)

Dimensions in Millimeters



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